SURFSCAN 6200 for 4inch wafers

IMPORTANT: Do not use it for thick wafers (thickness > 1um)!

- LOG IN using the access code: boss (if the keyboard is not working use the virtual keyboard on the monitor)
- 2. Double click on the icon SCAN
- 3. Select the option Recipe (upper left corner) /Load
- Load one of the Standard recipes: UCSB GAIN4 0.16-1.6 - for 4 inch wafers, gain4 (0.16-1.6)um UCSB GAIN2 1.6-28 - for 4 inch wafers, gain2 (1.6-28)um Do not make any changes in the recipes!
- Press OK, and recipe will be loaded (It will show the name of the recipe at the top of the monitor)
- 6. Select the option Recipe
- 7. Scroll down to option Save as
- 8. Save as give a new name to the recipe (usually your name/company name etc.)
- 9. Select the option Recipe/View/Modify
- 10. Modify your recipe (wafer diameter, edge exclusion, gain, threshold etc).
- 11. On the same page select the option **Bin Split** and click on **Default Bin** This would update changes in your recipe.
- 12. Save the changes
- Loading wafers in the carrier: (For 4" wafers use white carrier for loading 4" wafers-right indexer)
- 14. Load the wafers into the carrier
- 15. Make sure wafer face is up (Major cut could be facing either way.)
- 16. Place cassette in the right indexer (for 4")
- 17. Make sure cassette is placed in the right place and sitting properly
- 18. Select on the monitor option CASS (Cassette) (Wait for the tool to read all the wafers in the cassette.)
- 19. If you want to scan ONLY ONE wafer, select the wafer and click on **START** (upper bar)
- 20. Wait for the wafer to be picked up and scanned. Record results of the scan.
- 21. If you want to scan multiple wafers select option AUTO, then START
- 22. When the scan is complete, click on the HOME option, select RECIPE/exit, and LOG OFF
- 23. Log in in the LOG BOOK and write details regarding your scan/or issues

IMPORTANT: PLEASE LOG OFF after using the tool!